

Application diverses 3D... *...en sciences des matériaux et sciences de la vie*

Marco Cantoni

Centre Interdisciplinaire de Microscopie Electronique
(EPFL-CIME)



Since August 2008: NVision 40

e-beam: ZEISS Gemini
1-30kV, 1nm @ 30kV, 2.5nm @1 kV

Ion-beam: 1-30kV, 4nm @ 30kV

EDS X-MAX (SDD) 80mm² detector

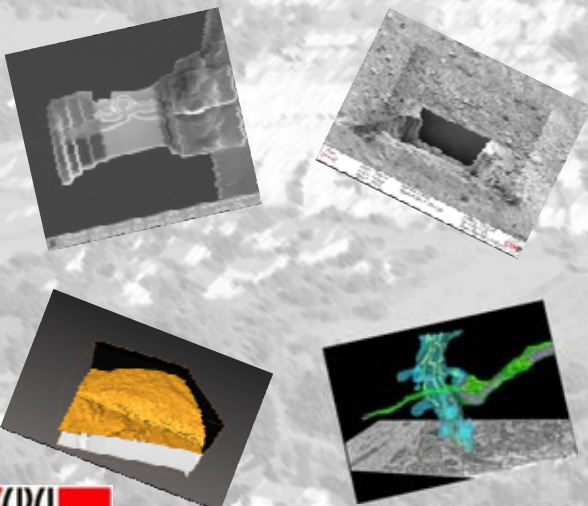
Kleindiek micromanipulator (TEM prep)

>4000 Ga beam hours (~2 sources) / year

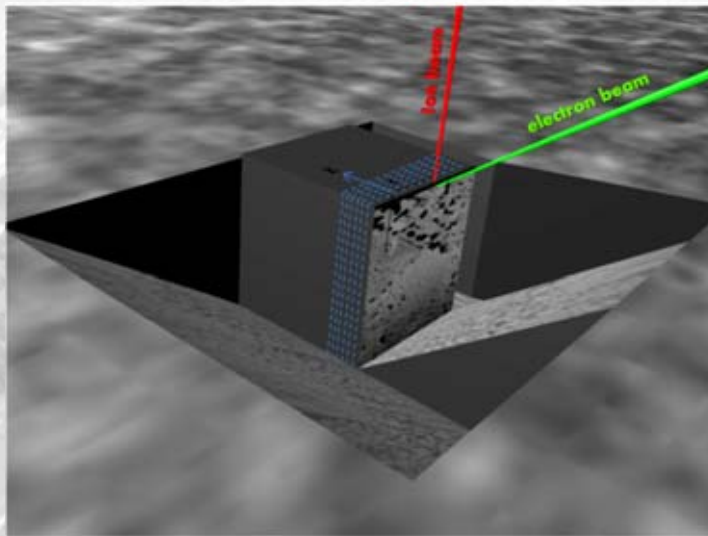


FIB Applications @ CIME

- o Materials Science:
TEM Lamellae preparation
cross-sectioning, 3D reconstruction
3D EDX (in collaboration with ZEISS)
3D reconstruction of biocompatible materials
- o Life Science:
Serial sectioning of Brain tissue:
SUPER-STACKS



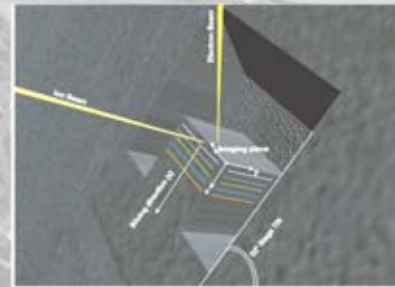
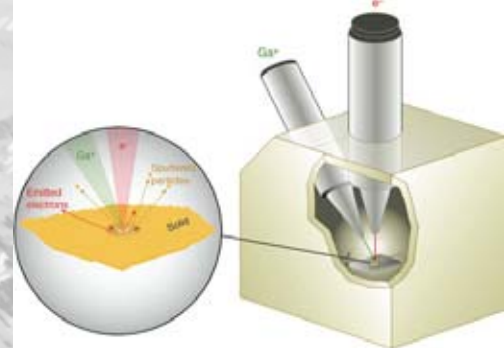
3D FIB/SEM: volume reconstruction



Three-dimensional analysis of porous BaTiO₃ ceramics using FIB nanotomography

L. HOLZER, F. INDUTNYI, PH. GASSER, E. MÜNCH & M. WEGMANN
EMPA, Swiss Federal Laboratories for Materials Testing and Research, 1015, 8600
Dübendorf, Switzerland

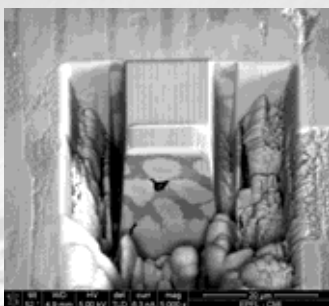
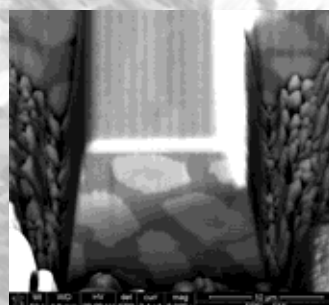
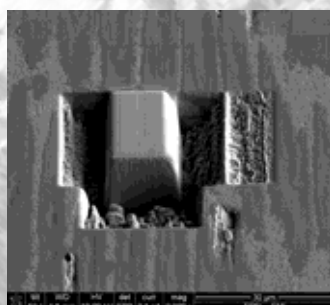
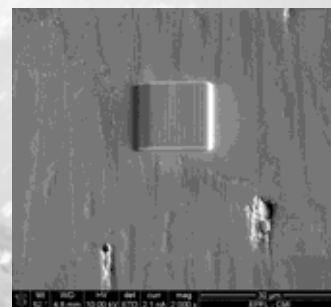
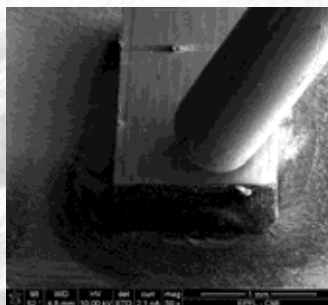
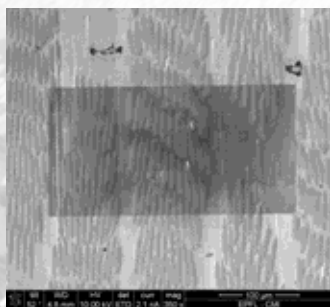
Journal of Microscopy, Vol. 216, Pt 1 October 2004, pp. 84–95



key to success:

- o Choice of parameters
 - o What do I need resolution/pixel/voxel
 - o Conditions of the microscope: HT, current
 - o Detector(s): Which image information do I need for a successful segmentation ?
- o Stable environment !
- o Segmentation, image processing !
- o Specimen preparation !

3D slicing of multifilament Nb₃Sn superconductor

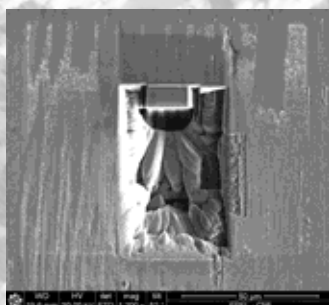
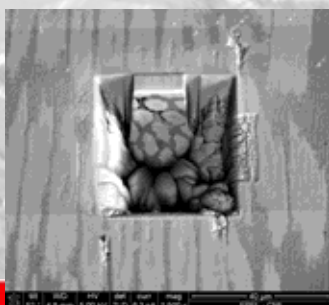


Preparing for slicing



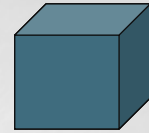
Automated milling and imaging of 170 slices (10h)

the end



3D FIB/SEM: volume reconstruction

"Leitmotiv"
Isometric voxel size $x = y = z$

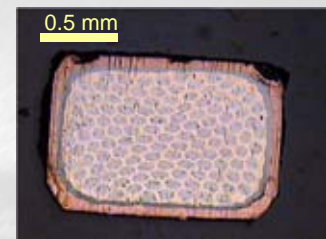


- o Slice thickness (z) = image pixel size (x, y)
Z dimension \sim X or Y, typical: 10nm, possible 5nm (3nm)
- o Image dimensions / data size (8-bit grey level tiff):
 - o 1024 x 786: 800 slices \rightarrow 640 Mb
 - o 2048 x 1572: 1600 slices \rightarrow 5 Gb
 - o 3096 x 2358: 3000 slices \rightarrow 21 Gb
- o Acquisition time \sim 1min / slice
(40-60 slices / hour)
 \rightarrow high S/N ratio, beam current (1-1.5nA), detector efficiency
- o Dwell times/pixel 5- 15 μ sec. (detector signal \rightarrow 256 grey levels)
- o High throughput: minimise overhead, no tilting, rotating, drift correction
- o Z- Resolution: low kV !!!

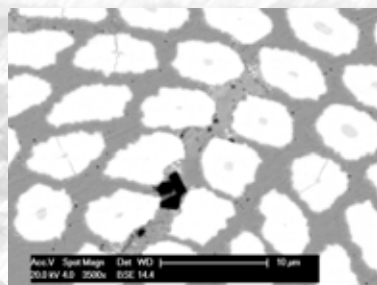
choice of parameters

Nb₃Sn multifilament superconducting cable

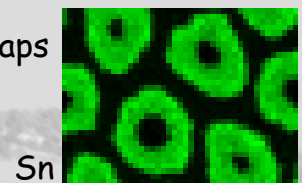
Nb₃Sn superconductor multifilament cable:
14'000 Nb₃Sn filaments (diameter \sim 5 μ m) in bronze matrix



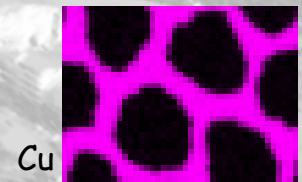
Solid State BSE detector
20kV acceleration voltage



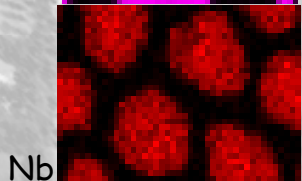
EDX maps



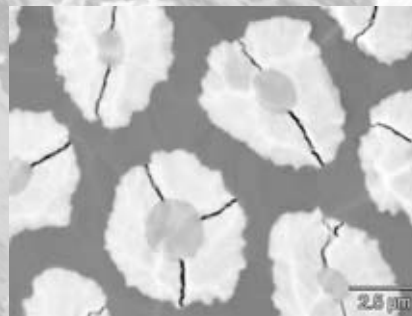
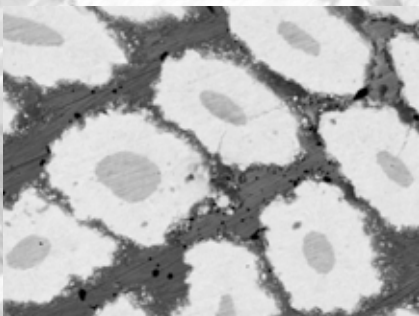
Sn



Cu



Nb



Mechanical polishing \leftrightarrow Ar ion beam polished

choice of parameters

in-chamber
ET-detector
SE

in-column
"InLens"
SE-detector

in-column, "energy-selective" EsB
BSE-detector

SE detection

BSE detection

2 μm EHT = 1.80 kV
WD = 5.1 mm
Mag = 7.27 K.X

2 μm EHT = 1.80 kV
WD = 5.1 mm
Mag = 7.27 K.X

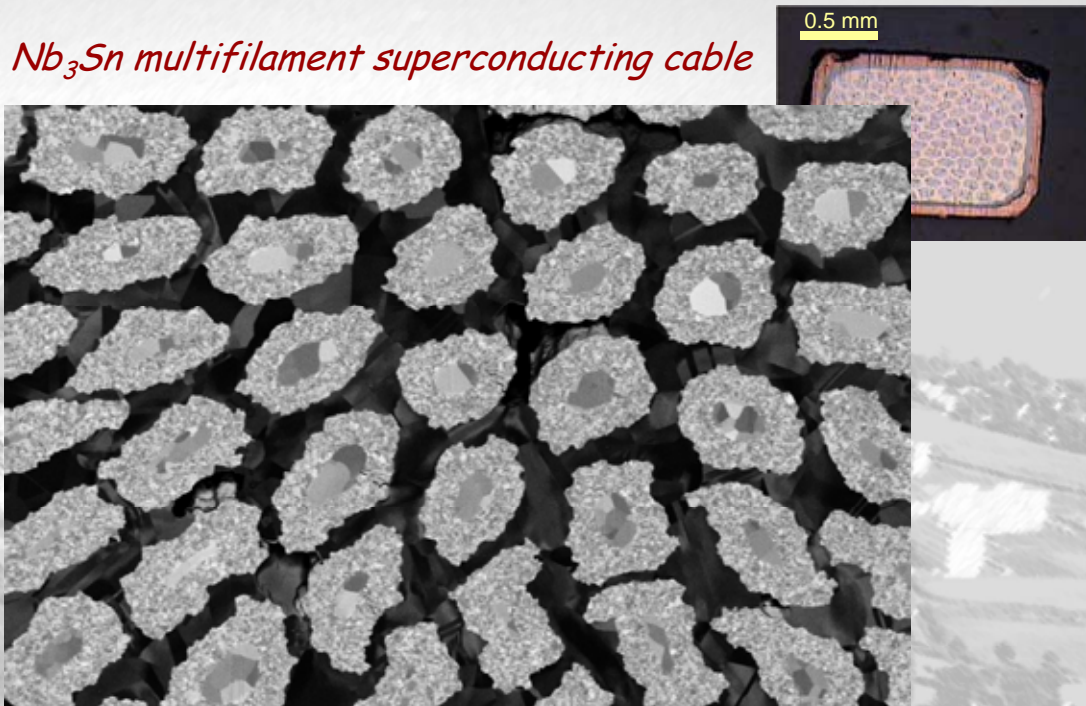
2 μm EHT = 1.80 kV
WD = 5.1 mm
Mag = 7.27 K.X

Signal A = ESB
Aperture Size = 120.0 μm
Width = 15.73 μm
Time = 17:19:41
Image Pixel Size = 15.36 nm

EPFL
ÉCOLE POLYTECHNIQUE
FÉDÉRALE DE LAUSANNE

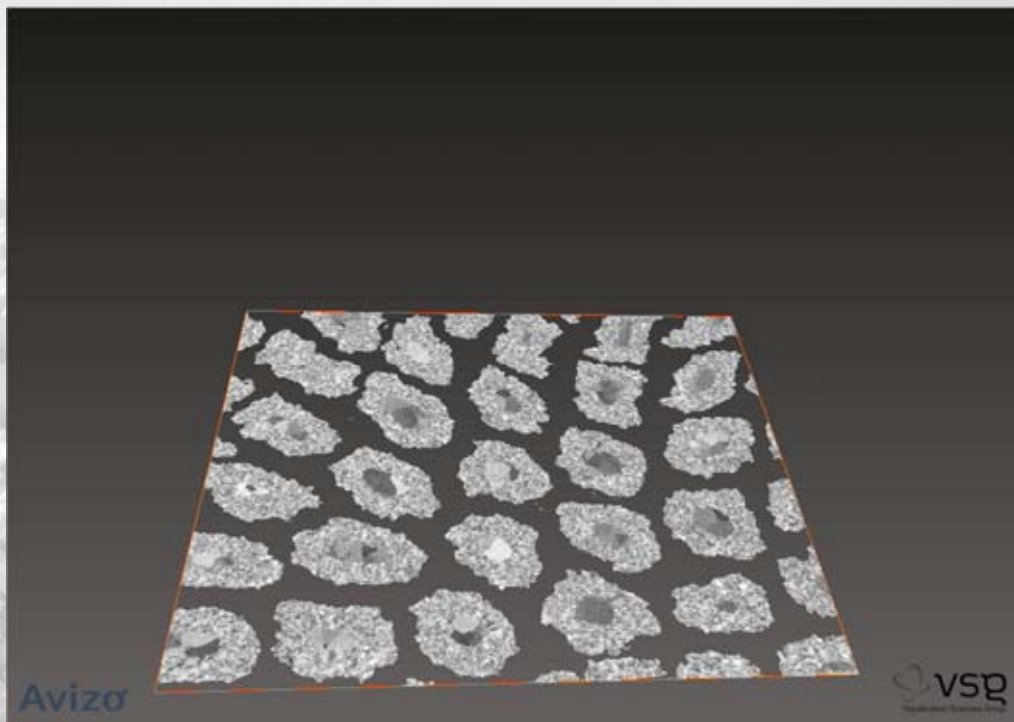
CiMe

Nb₃Sn multifilament superconducting cable



Nb₃Sn superconductor multifilament cable:
14'000 Nb₃Sn filaments (diameter ~5 μm) in bronze matrix
1.8kV EsB detector: Materials & orientation contrast

3D Microanalysis by FIB/SEM volume reconstruction

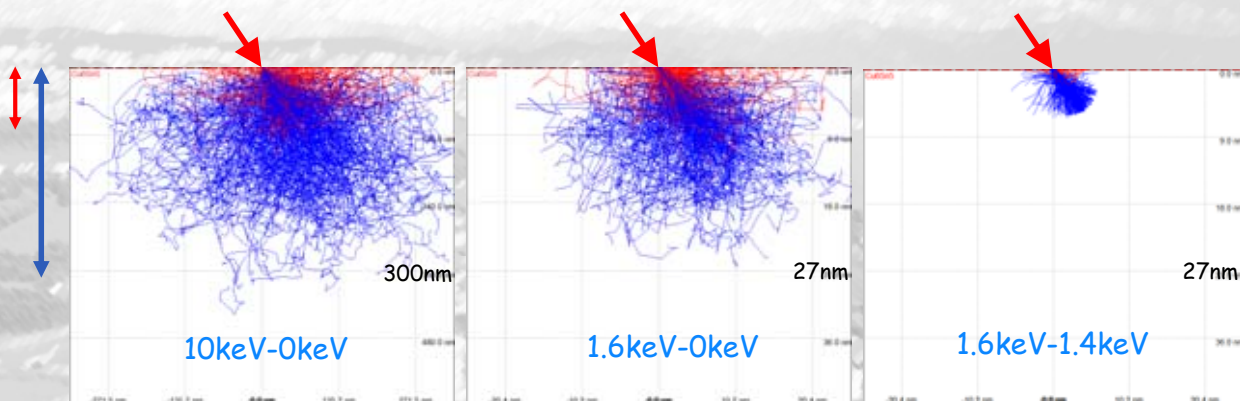


Materials & grain contrast
2048x1536x1700, (10x10x10nm voxel), 28hours

3D FIB/SEM: volume reconstruction

What is the spatial resolution of BSE electrons ?

Scatter range in Nb_3Sn :



HT

10keV

1.6keV

1.6keV
(low loss, EsB grid at 1.4kV)

BSE esc. depth

100nm

10nm

2-3nm

penetration

300nm

20nm

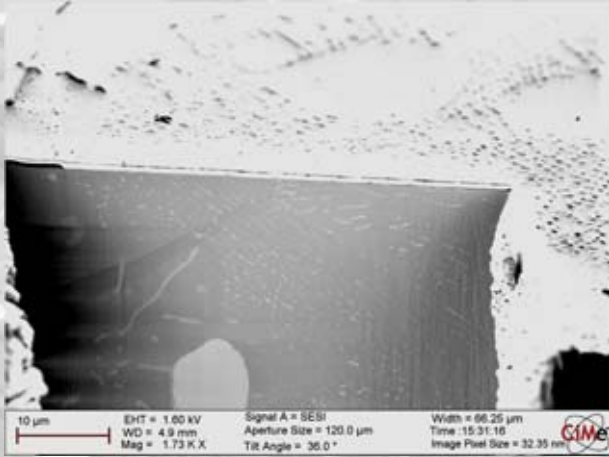
(20nm)

Energy selective BS

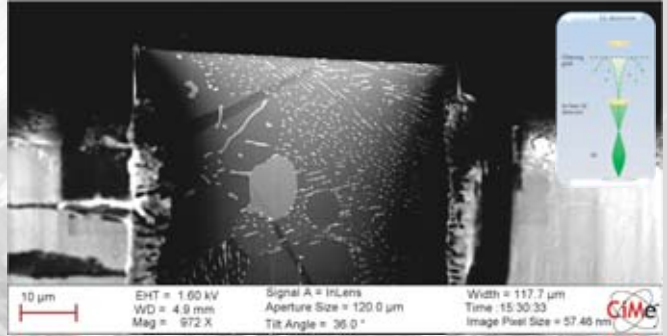
Scatter range in Nb_3Sn :
Monte-Carlo Simulation (CASINO 2.42) of electron trajectories
backscattered electrons

Pb-free solder: "one detector is not enough"

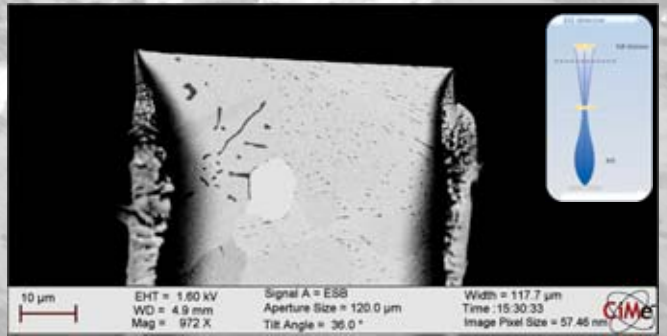
M. Maleki,
EPFL-LMAF



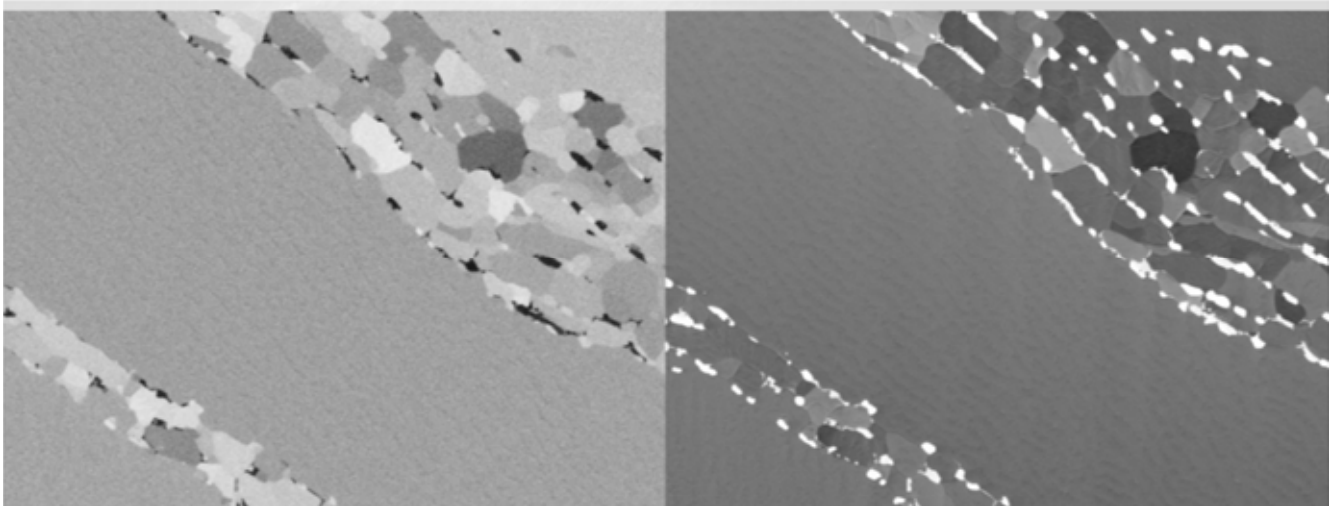
ETD (SE classic)



InLens: SE low energy



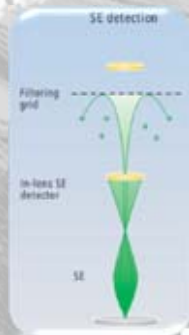
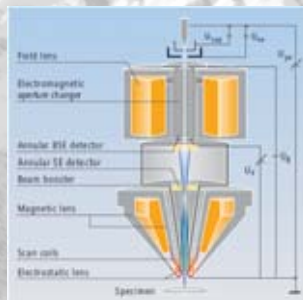
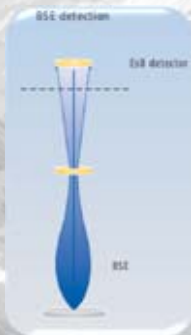
EsB: Energy selective Backscattered

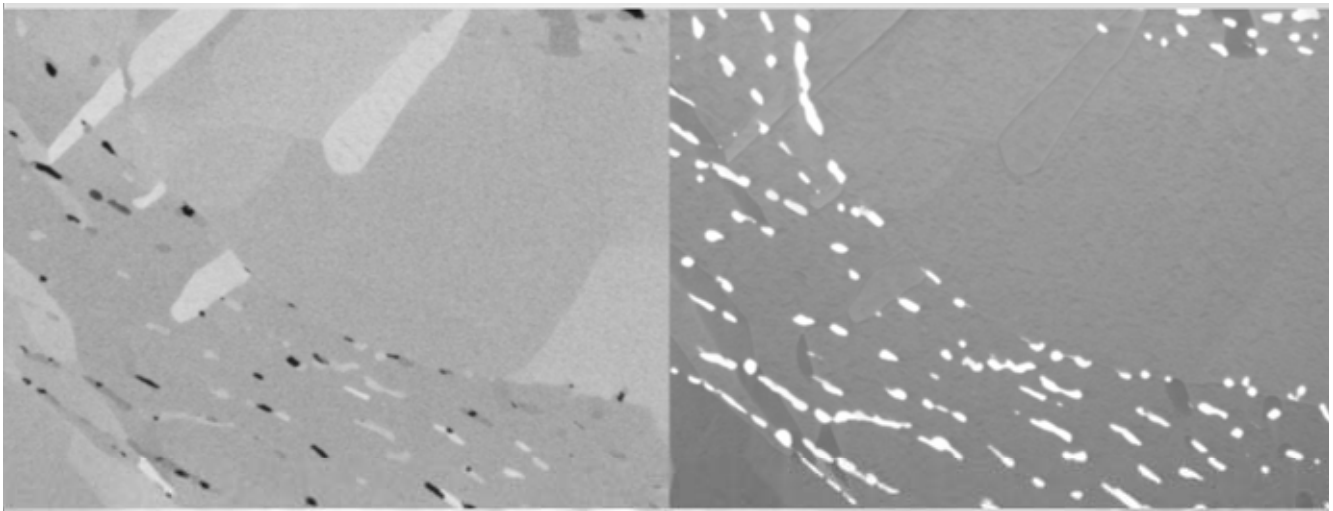


EsB

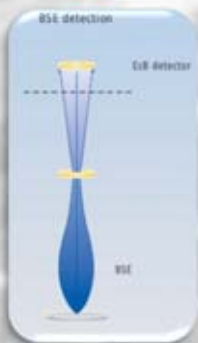
10x10x10nm voxel size, 2048x1536x2000 pixel/slices
2 images (3Mb) / slice 12Gb data

InLens SE



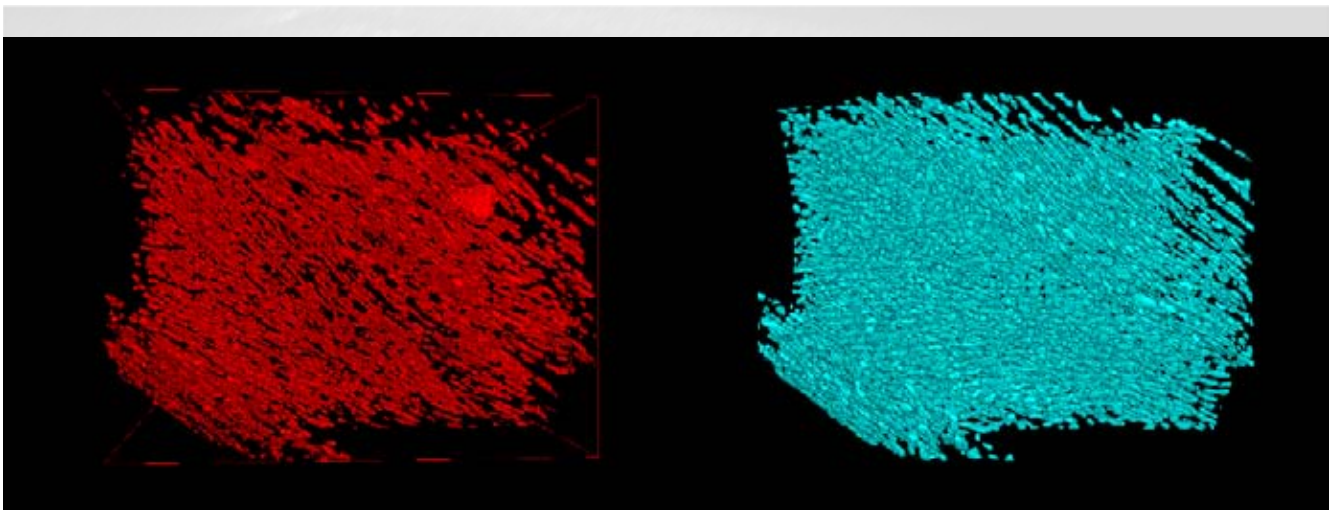
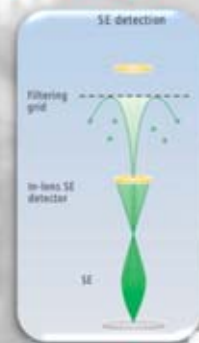


EsB



10x10x10nm voxel size, 2048x1536x2000
 2 images (2x3Mb) / slice ...! (DUAL Channel !)
 12Gb data

InLens SE

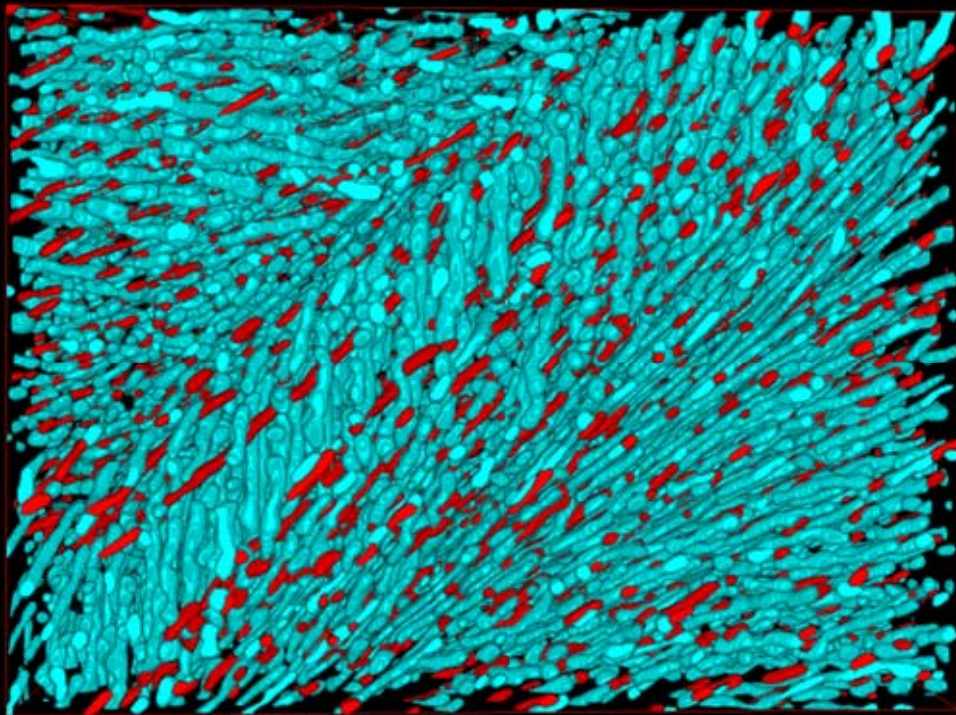
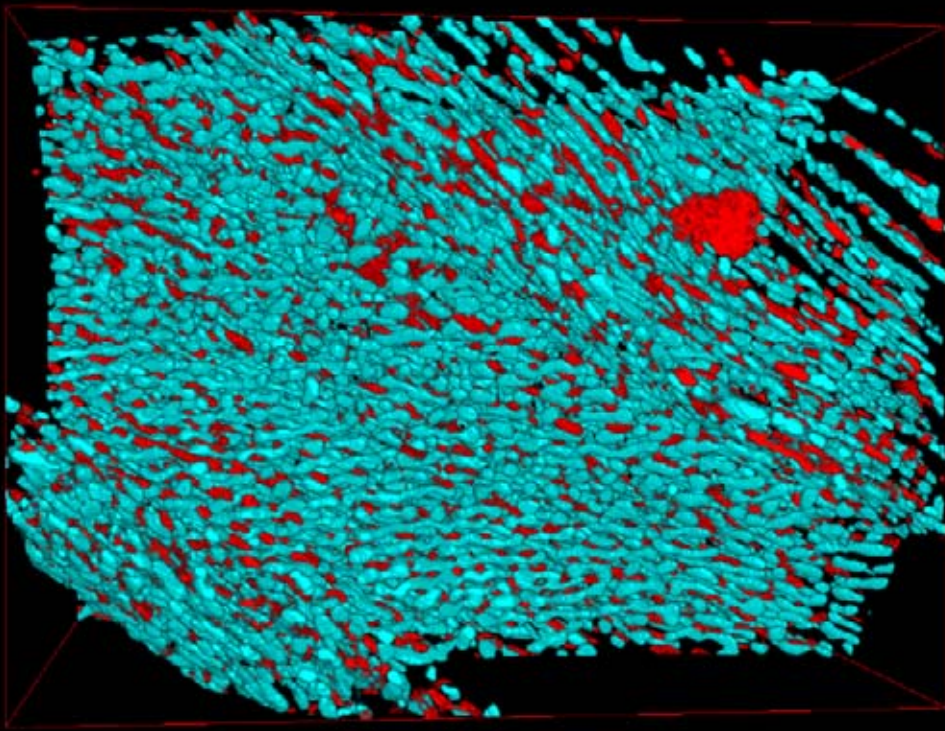


Phase 1
 Dark in EsB image
 White in SE-InLens

Phase 2
 White in SE-InLens - Dark in EsB image

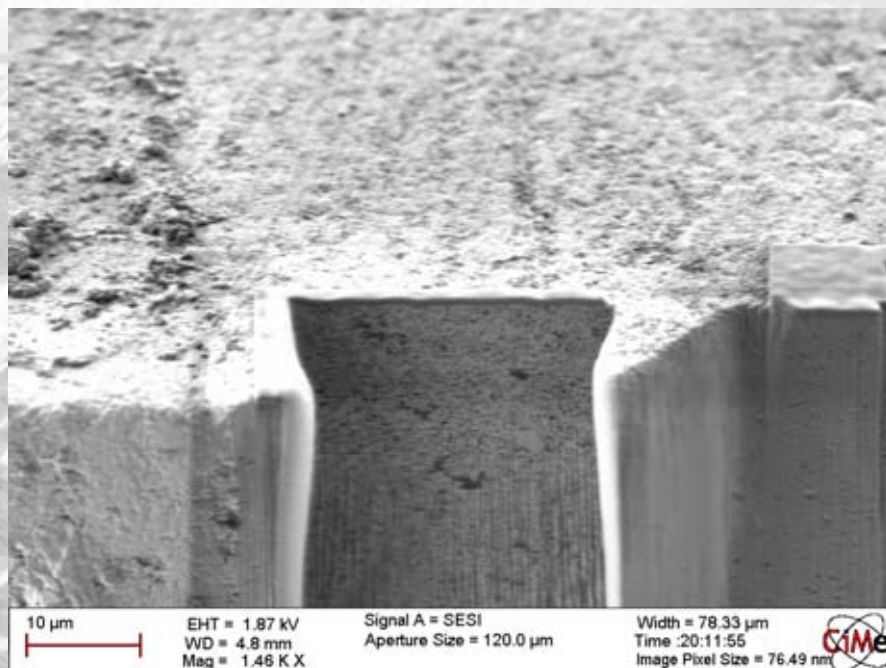
10x10x10nm voxel size, 2048x1536x2000 pixel/slices
 2 images (3Mb) / slice 12Gb data





Solid Oxide Fuel Cell cathode

P. Tanasini, LENI

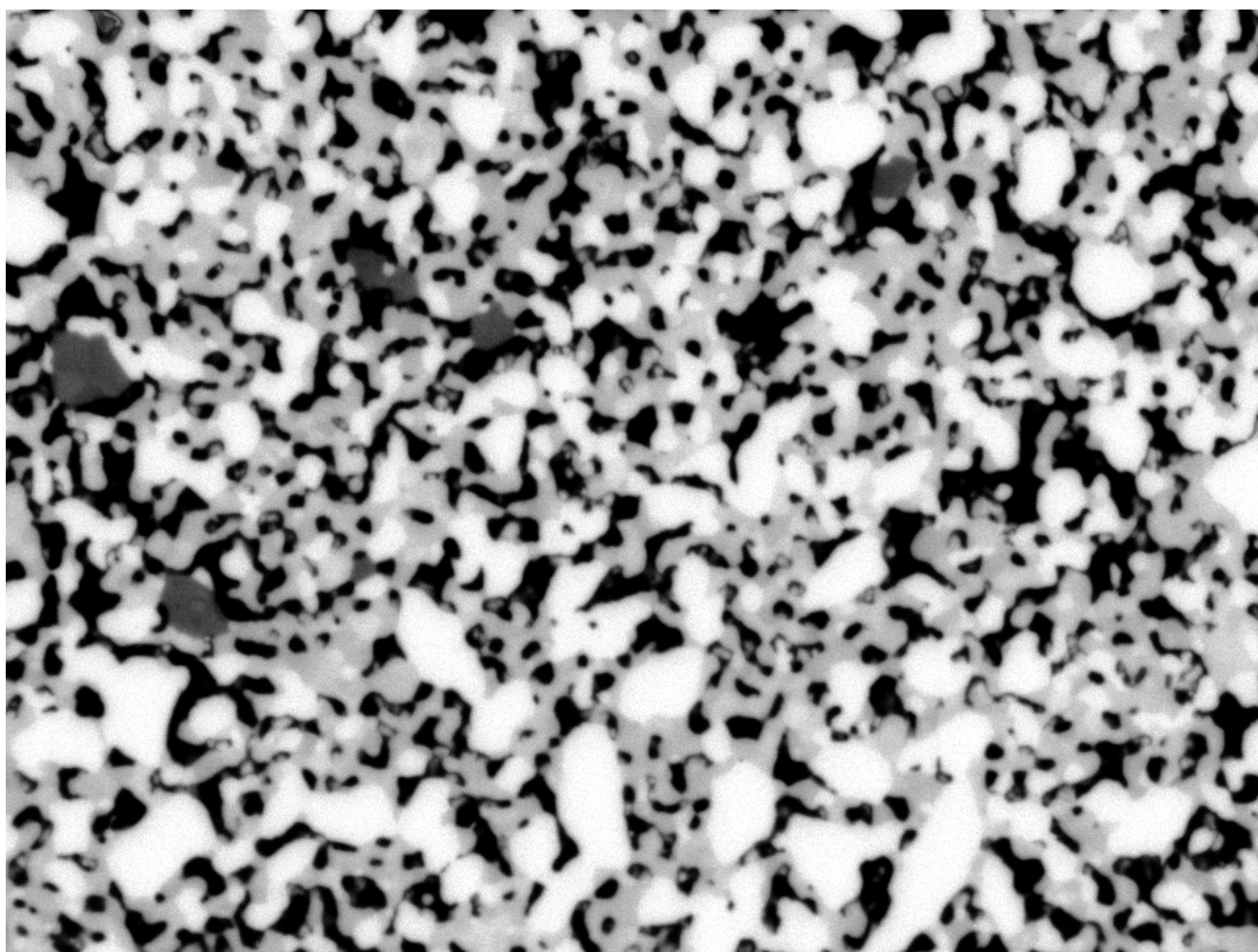


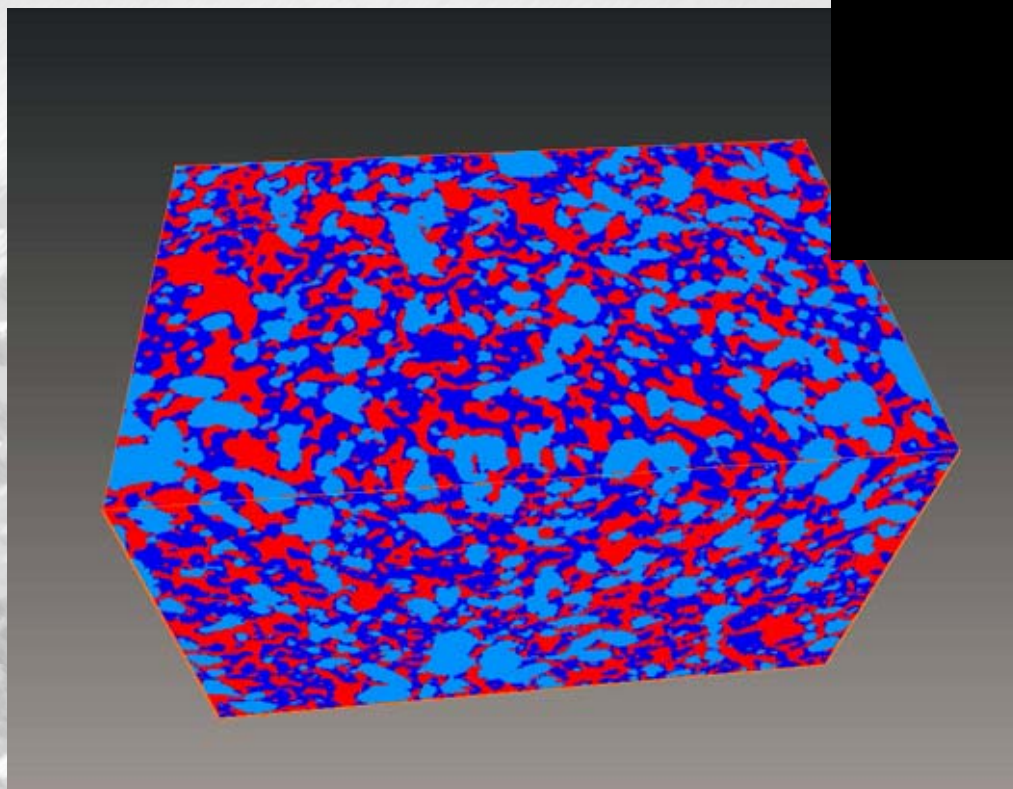
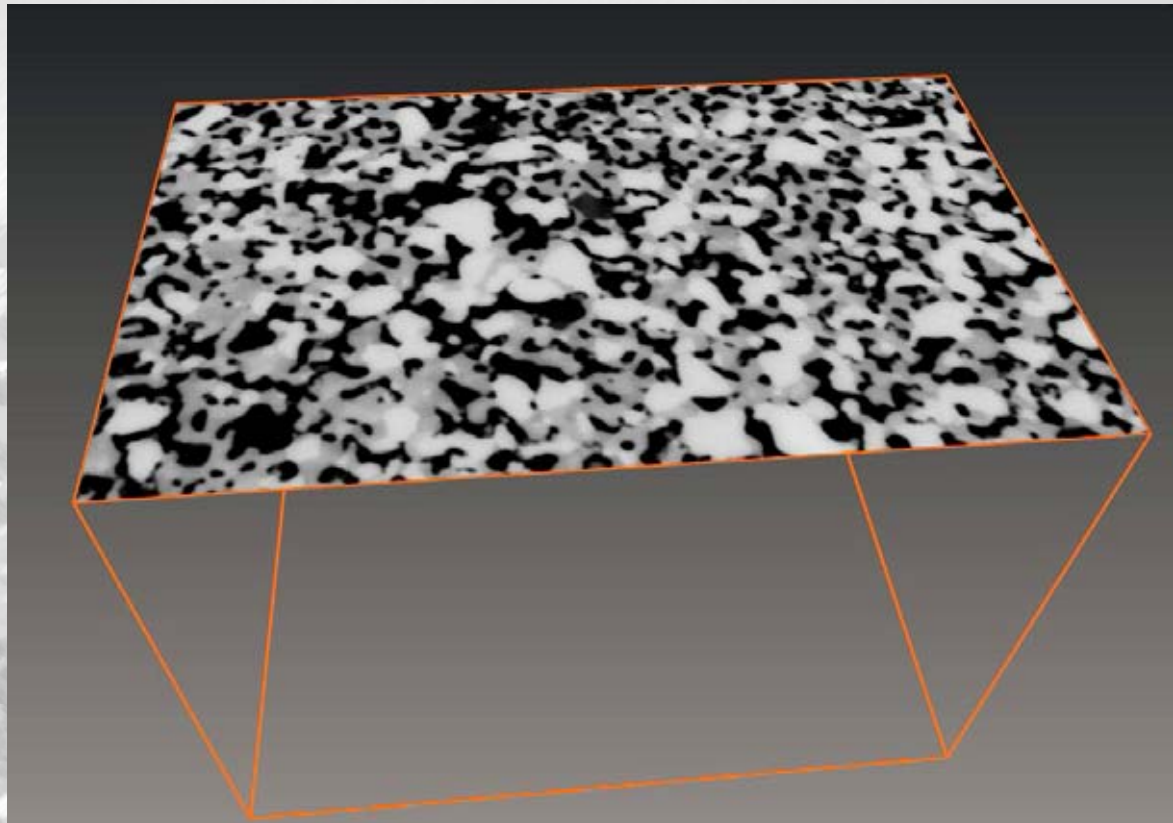
10 μm

EHT = 1.87 kV
WD = 4.8 mm
Mag = 1.46 K X

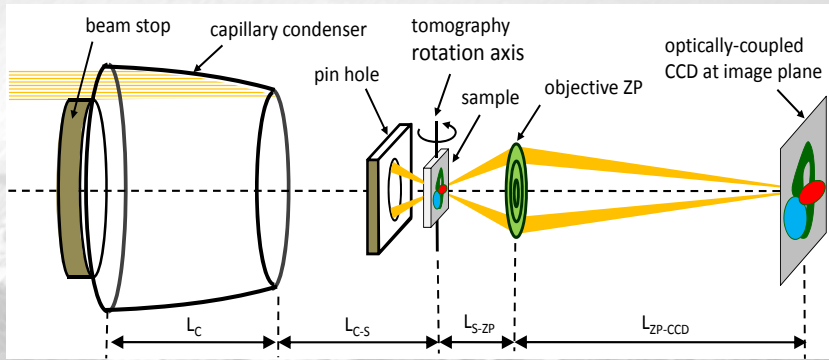
Signal A = SEI
Aperture Size = 120.0 μm

Width = 78.33 μm
Time :20:11:55
Image Pixel Size = 76.49 nm





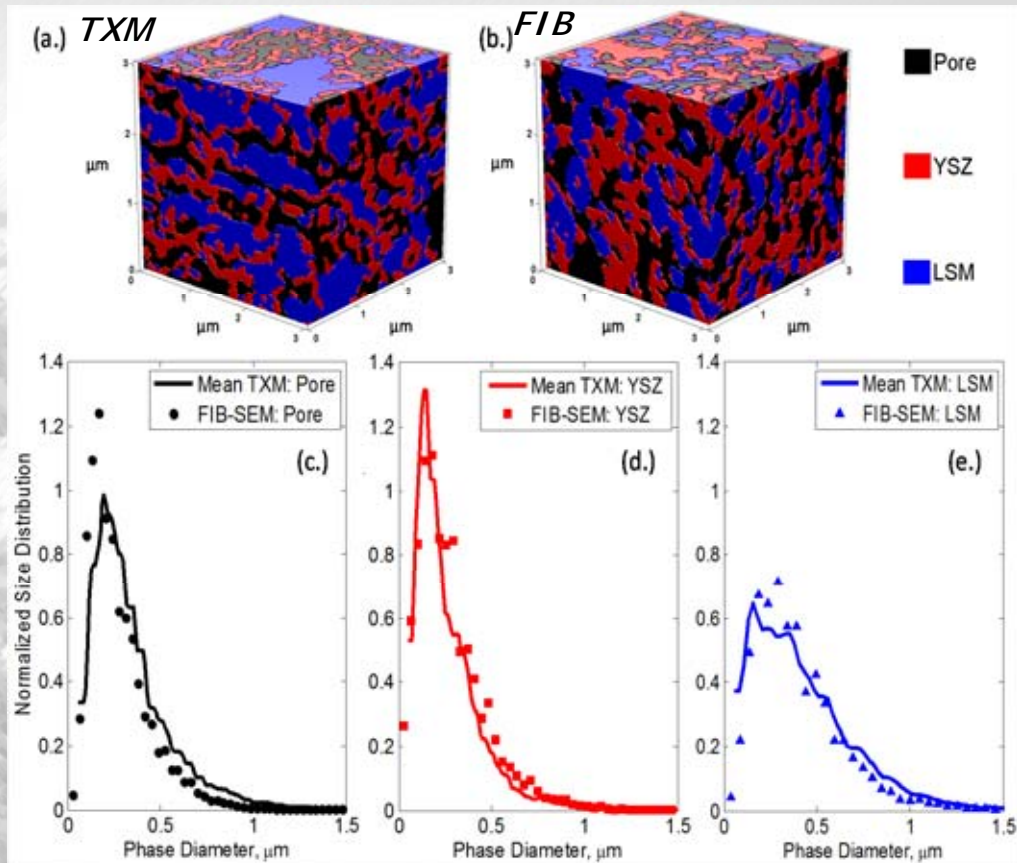
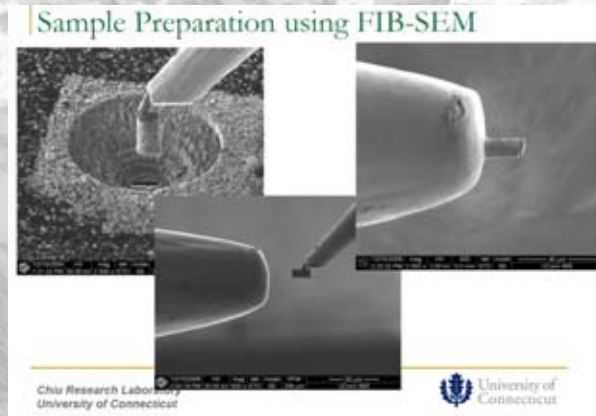
Comparison with Transmission X-ray Microscopy (TXM)



George J. Nelson, William M. Harris, Jeffrey J. Lombardo, John R. Izzo, Jr., and Wilson K. S. Chiu*

Joy C. Andrews, Yijin Liu, and Piero Pianetta
 Stanford Synchrotron Radiation
 Lightsource
 Stanford Linear Accelerator Center

Yong S. Chu
 National Synchrotron Light Source
 II
 Brookhaven National Laboratory



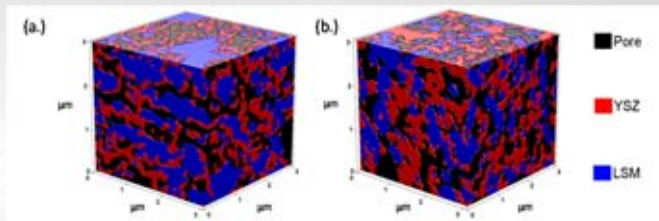


Table 1. Microstructural characterization results for the cathode samples obtained using x-ray nanotomography and FIB-SEM. The FIB-SEM results were down-sampled using 3×3×3 binning to allow comparison at comparable pixel size.

Parameters and Phases	X-ray Nanotomography		FIB-SEM	
Mean Phase Diameter (µm)				
Pore	0.34 (±0.045)		0.27 (±0.030)	
YSZ	0.27 (±0.045)		0.28 (±0.030)	
LSM	0.42 (±0.045)		0.40 (±0.030)	
Volume Fraction				
Pore	0.34		0.34	
YSZ	0.32		0.33	
LSM	0.34		0.33	
Interfacial Characteristics				
	Total	Effective	Total	Effective
TPB Length (m m ⁻³)	6.6E+13	6.0E+13	8.3E+13	7.0E+13
Interfacial Area (m m ⁻²)				
Pore-YSZ	7.7E+06	7.6E+06	7.4E+06	7.3E+06
Pore-LSM	2.9E+06	2.7E+06	3.4E+06	3.1E+06
YSZ-LSM	6.4E+06	6.1E+06	5.7E+06	4.9E+06

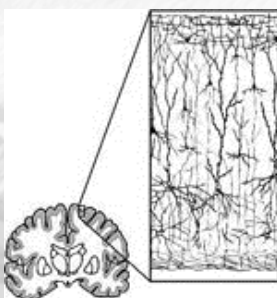


George J. Nelson, William M. Harris, Jeffrey J. Lombardo, John R. Izzo, Jr., and Wilson K. S. Chiu*

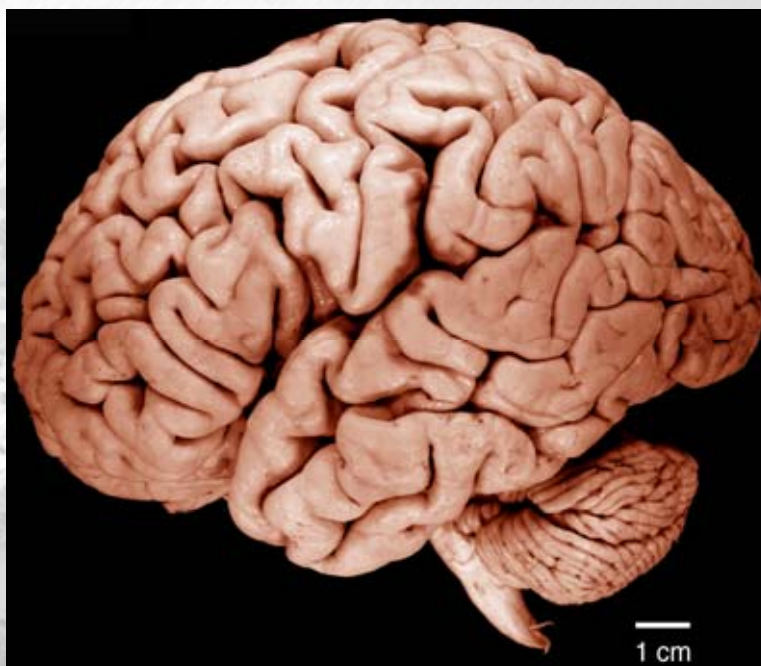
Department of Mechanical Engineering, University of Connecticut



A big Challenge in Life Science brain research



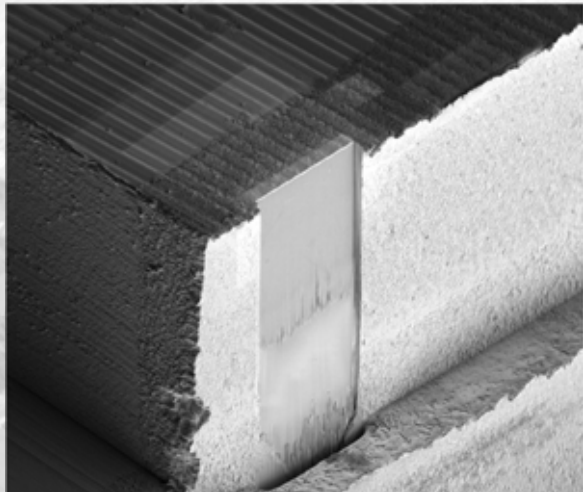
Simulation of brain function
with 10'000 neurons



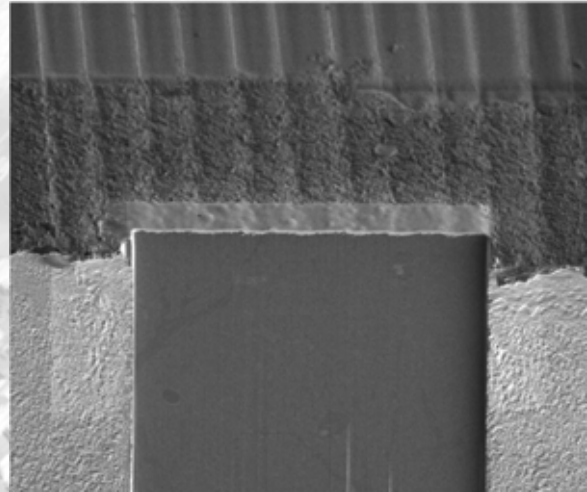
~1'000'000'000 neurons
~1'000'000'000'000 connections



What about FIB...?
Automated acquisition...!



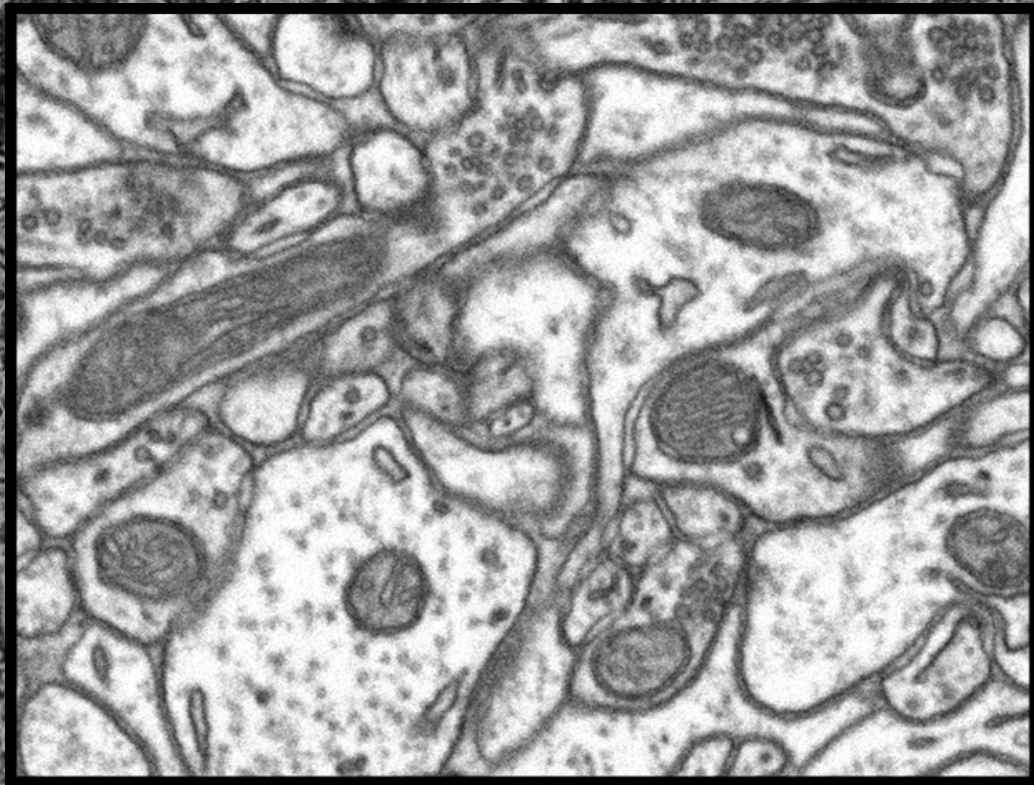
Secondary electron images of
mouse brain sample



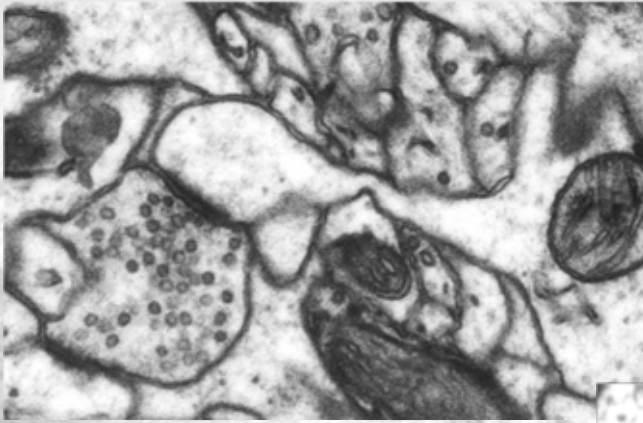
The imaging window - 100 um
width

What do we see...?

Back Scattered Electrons (BSE) contrast



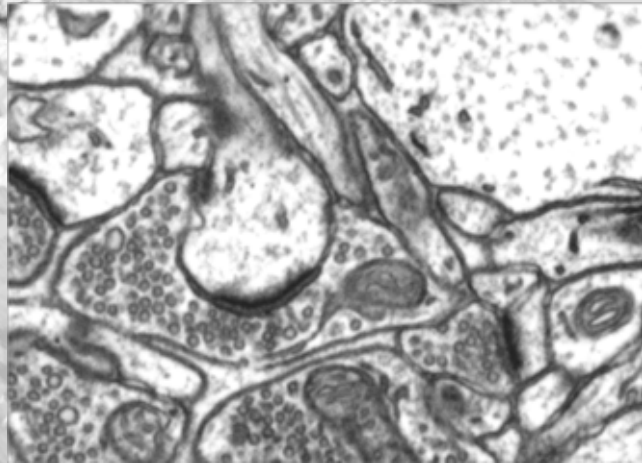
Resolution Bio-FIB...?



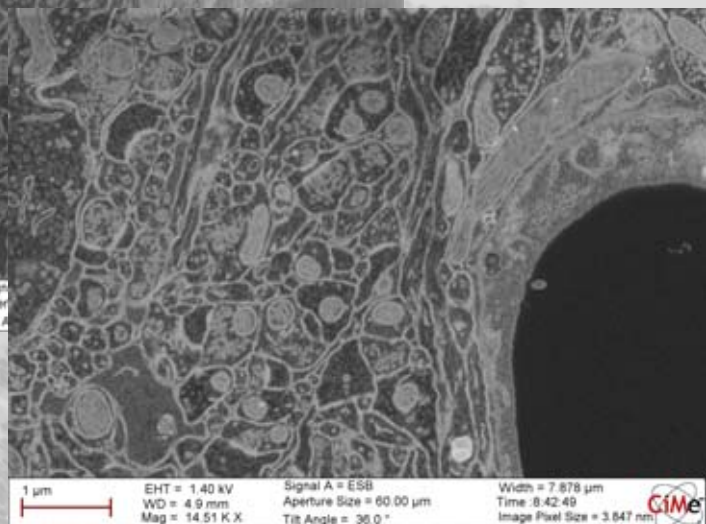
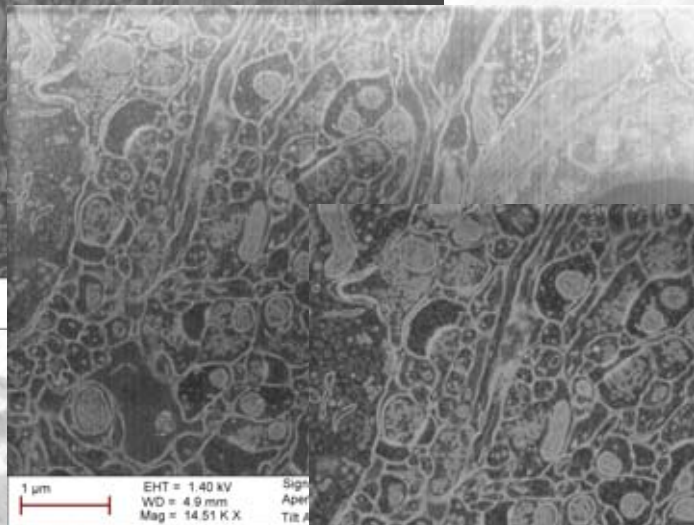
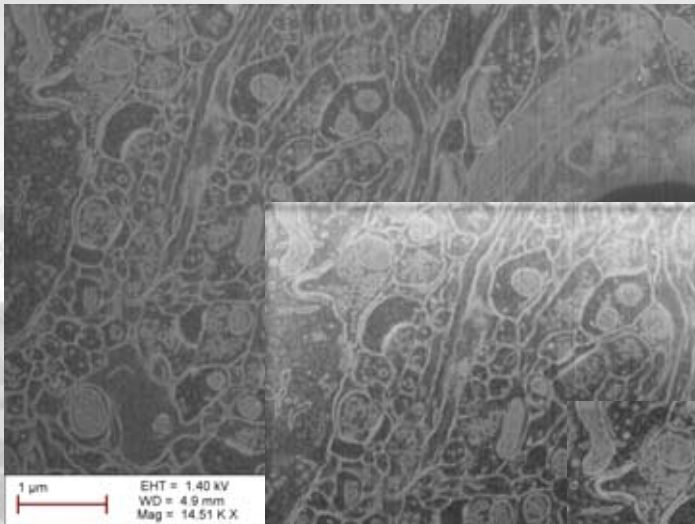
*TEM , 100kV
thin (50nm) section
prepared by Ultramicrotomy*

*Brain tissue:
synapse,
vesicles (~50nm)
mitochondria*

*SEM (FIB) , 1.4kV
"surface", (<5nm escape depth)*

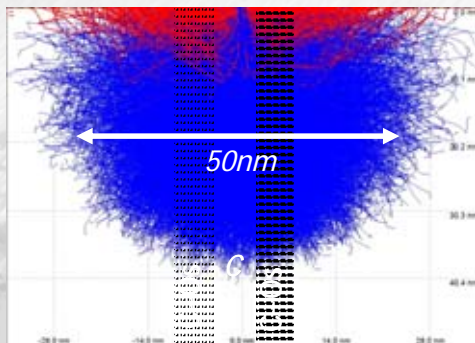


Which detector...?



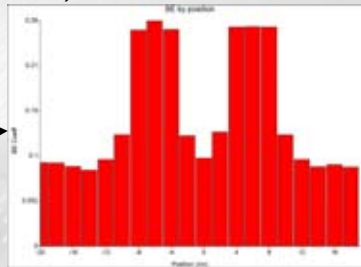
EsB detector: energy filtering, e-beam: 1.5kV

Monte-Carlo Simulations (Casino 2.42)



complete energy range

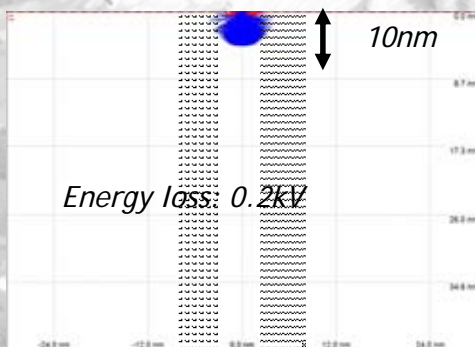
e-beam: 1.5kV



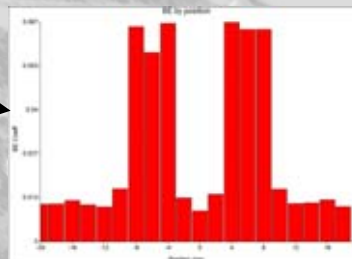
EsB grid 1.3kV

Selection of BSE with Energy loss of 0.2kV

Escape depth of "single" backscattered electrons < 5nm



Energy loss: 0.2kV



SUPER STACK

2048 x 1536 x 1600

Volume: 10 x 8 x 8 um

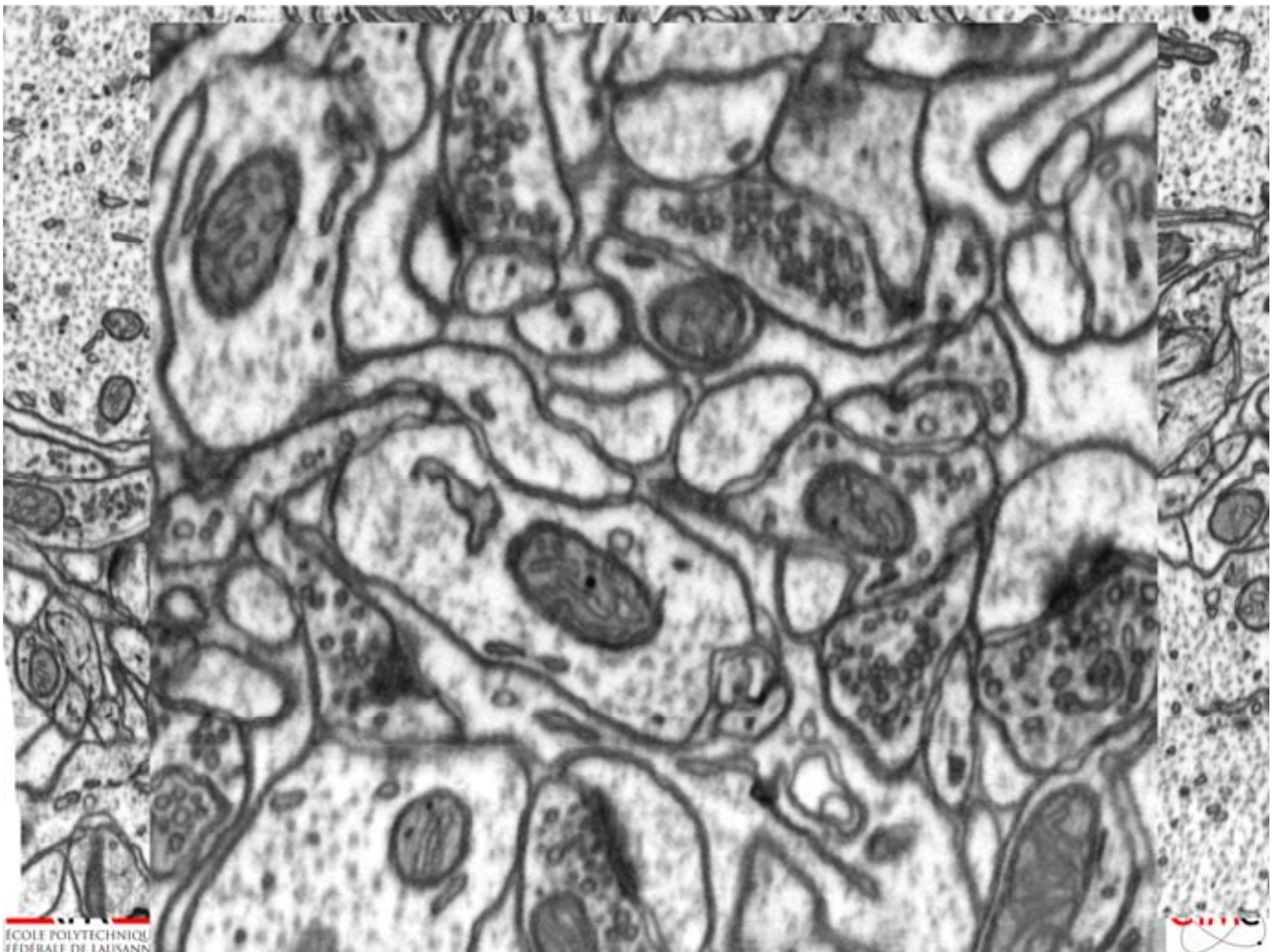
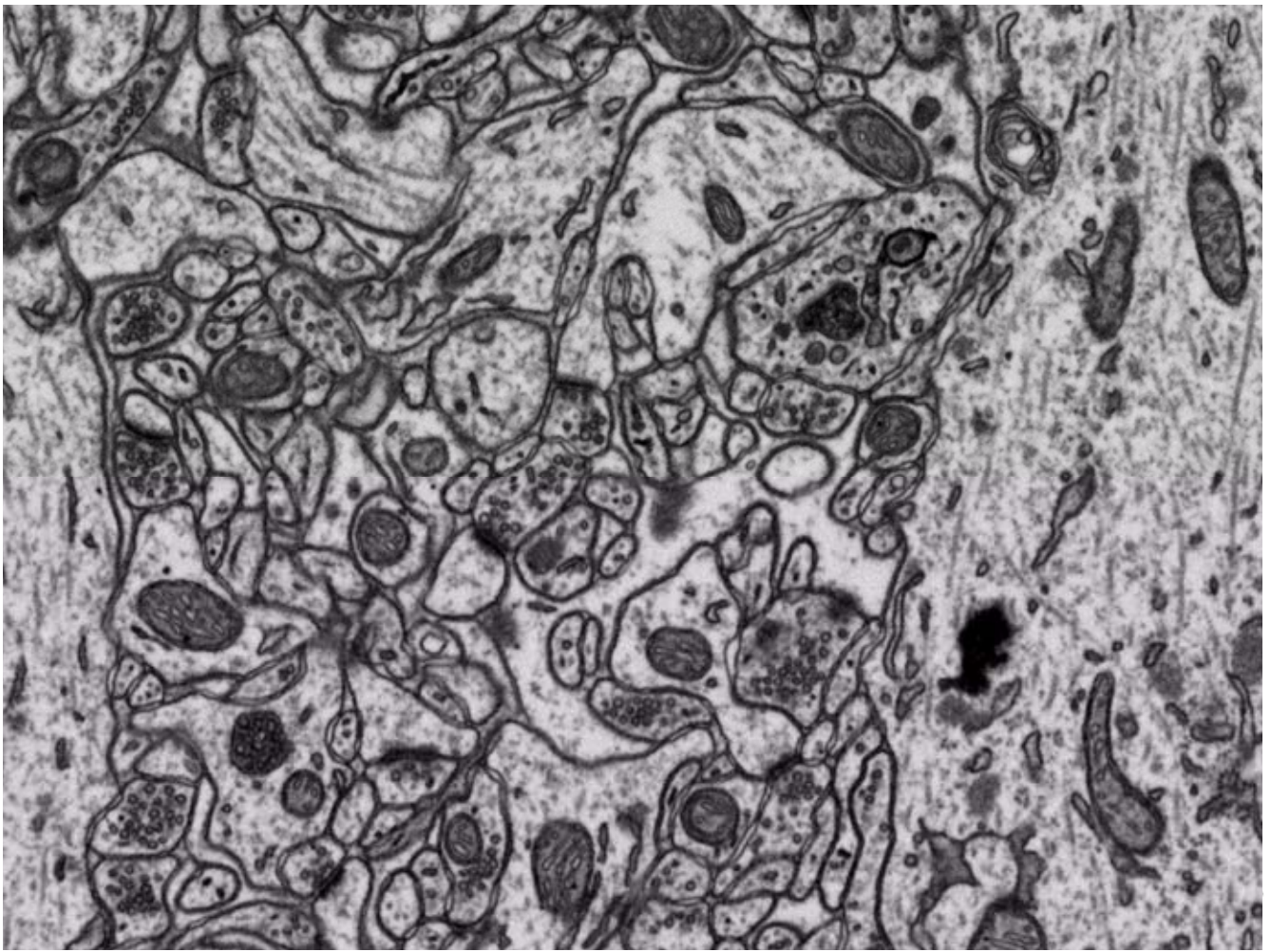
voxel: 5x5x5nm

2 days of fully automated acquisition
5 ~GB of Data



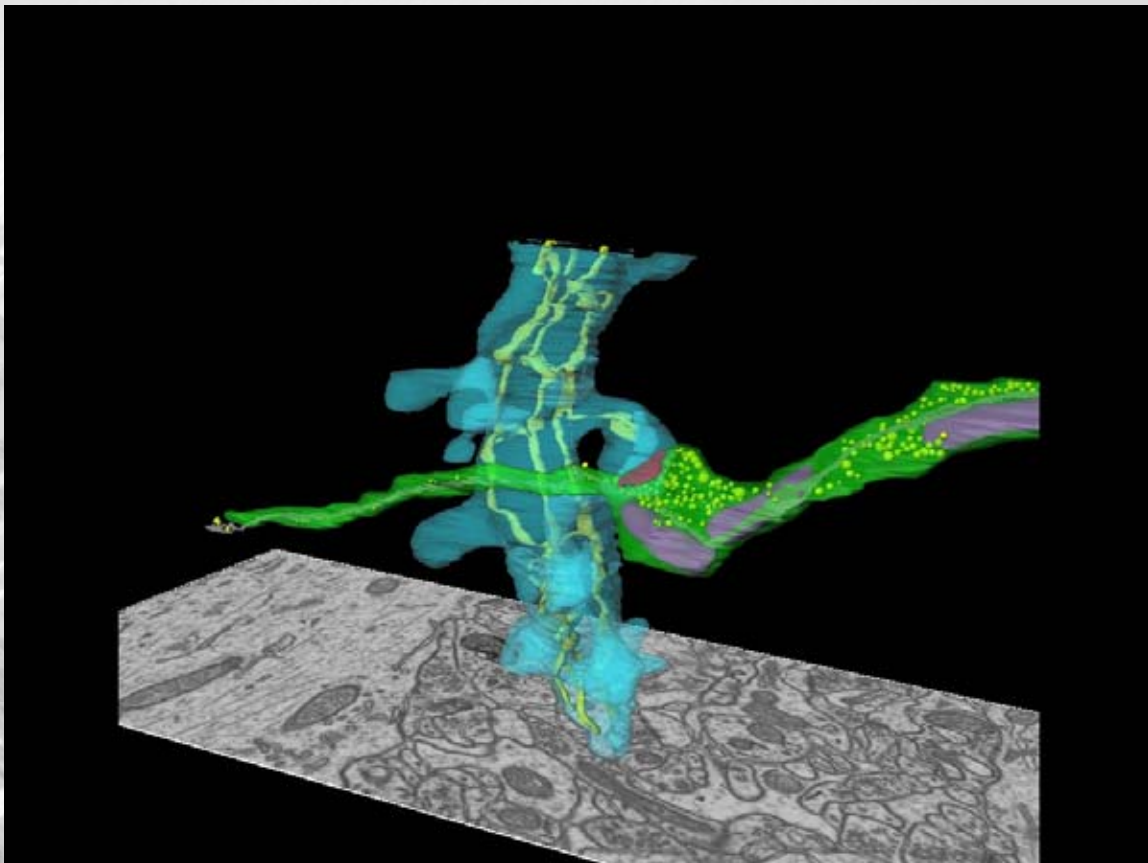
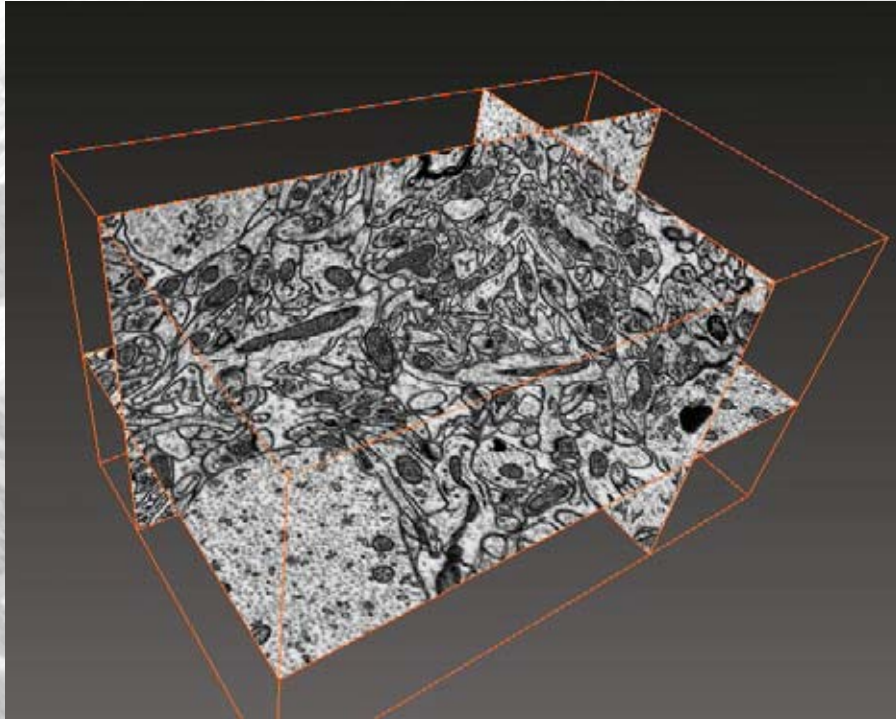
Milling current 700pA, 20sec. milling, 1.2min. imaging / slice





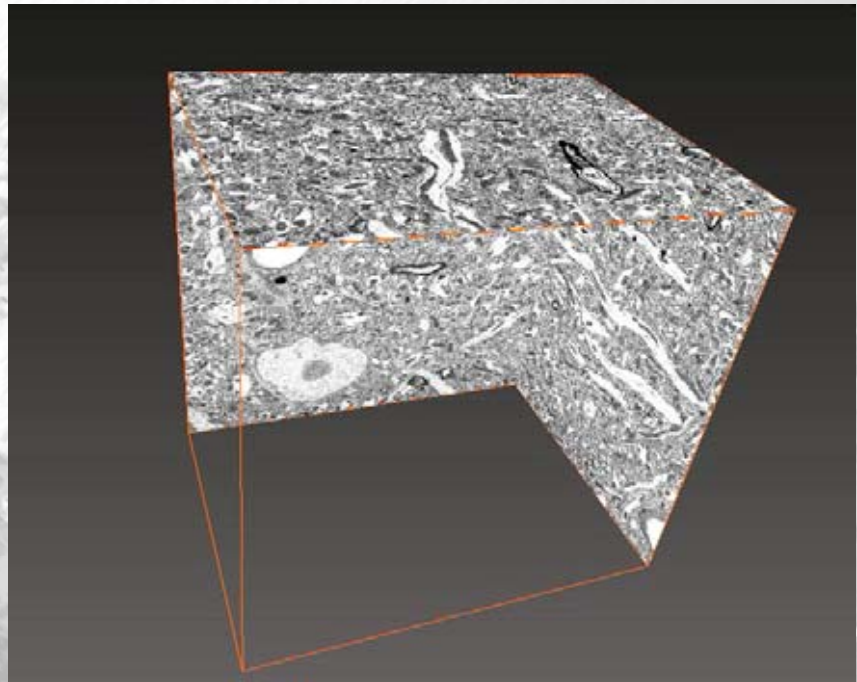
SUPER STACK(S)

2048 x 1536 x **1600** 10 x 8 x 8 μm voxel: 5x5x5nm
2 days of fully automated acquisition



Bigger volumes...!

- o *Voxel: 7.5x7.5x7.5nm*
- o *Image 3096x2304*
- o *3300 slices (48hours)*
- o *23x17x24 um*
- o *9700um³*
- o *~7000 synapses*
- o *23Gb data*

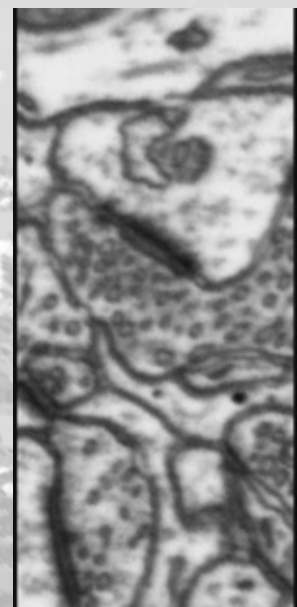
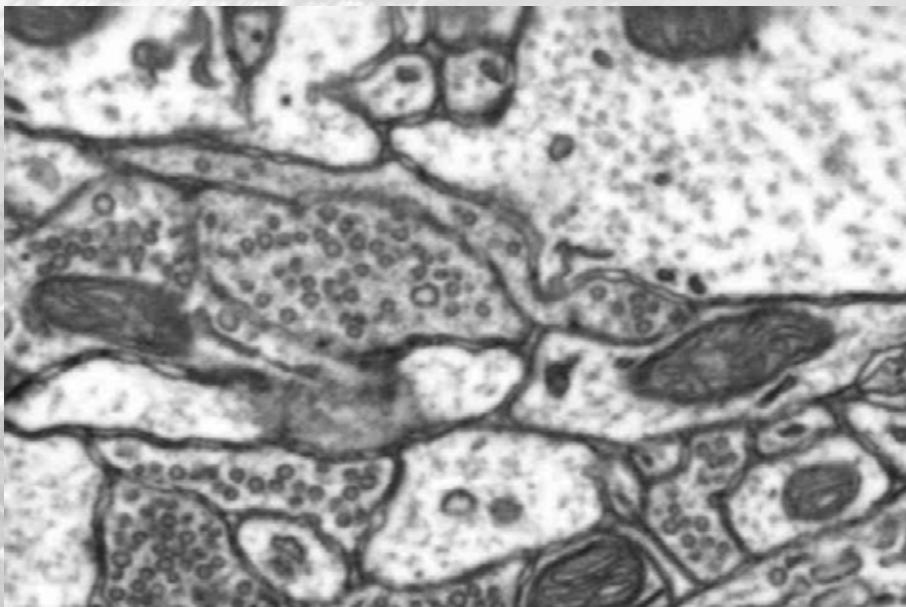


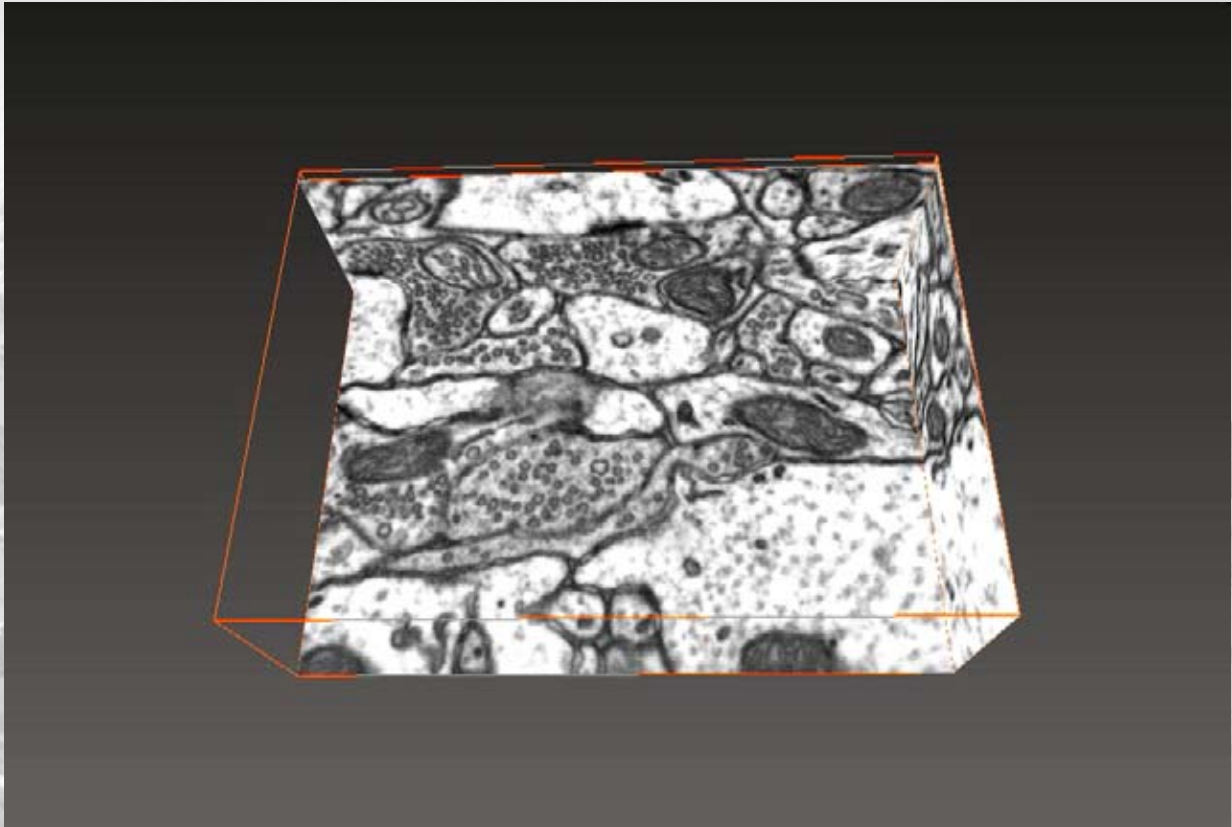
Where is the limit ...?

3nm x 3nm x 3nm voxel

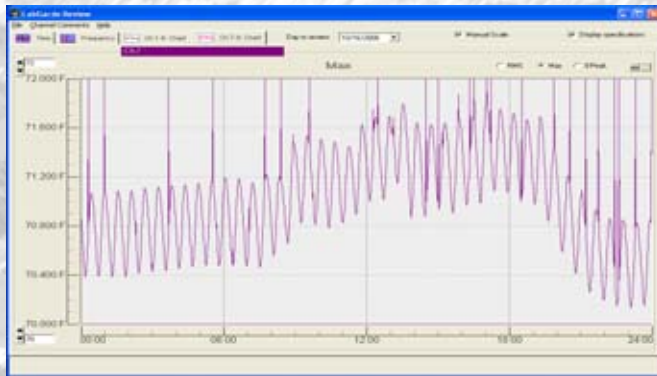
*X - Y plane
(image)*

*Y - Z plane
(virtual)*

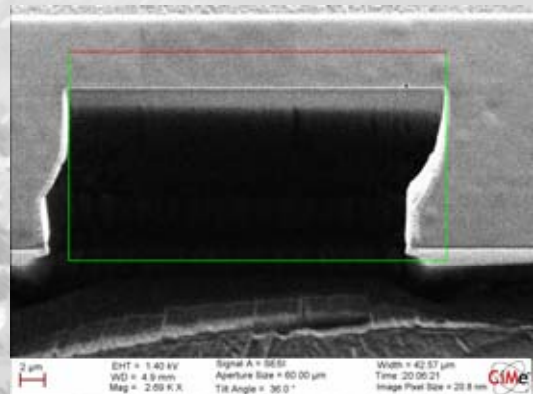




Very important: stable temperature



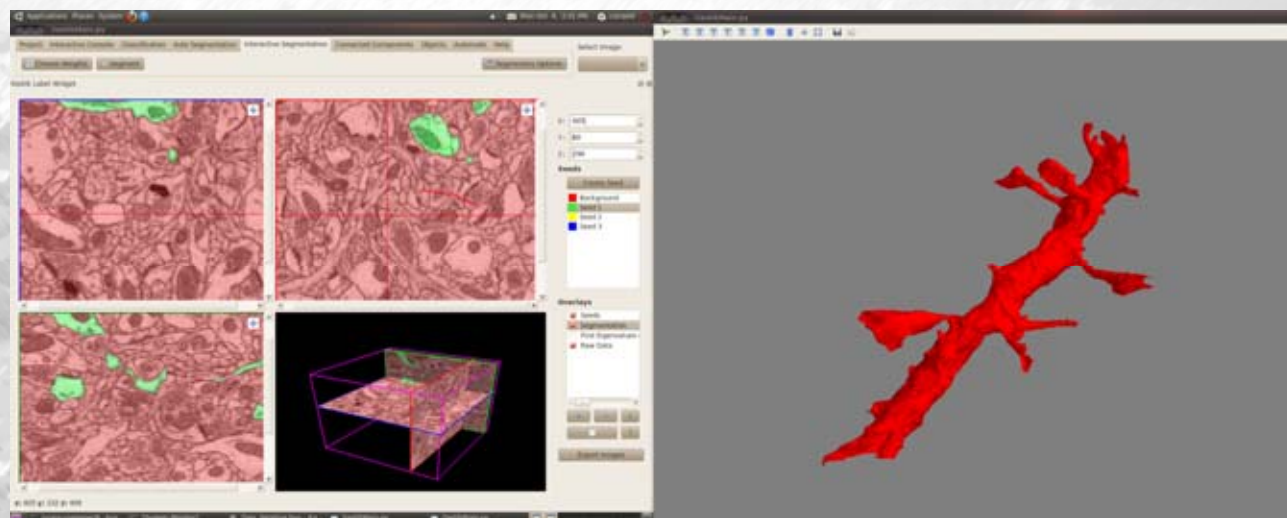
Cooling water (out)



Chamberscope LEDs...!

Automated segmentation of neuronal structures

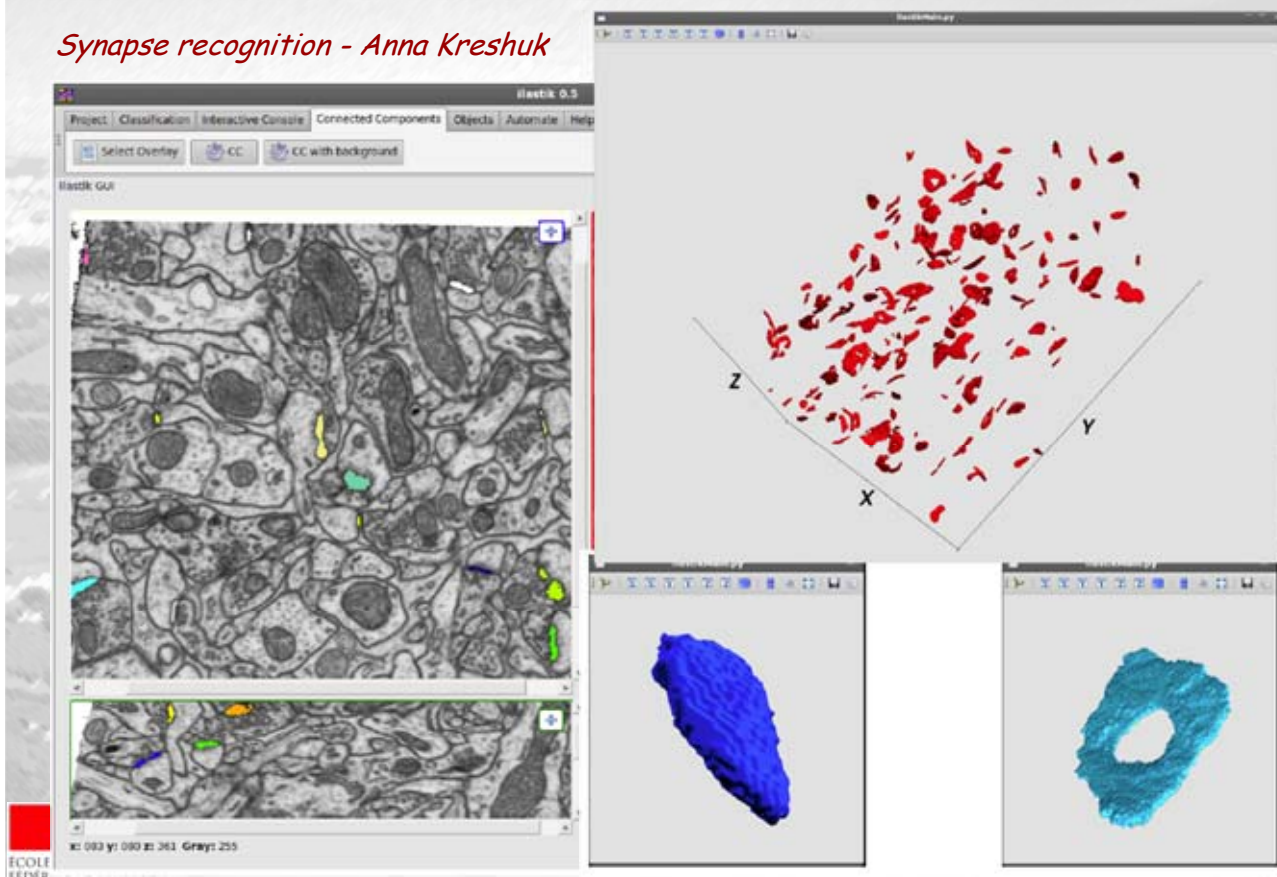
Ilastik v0.5 - Fred Hamprecht, University of Heidelberg



Automated segmentation of neuronal structures

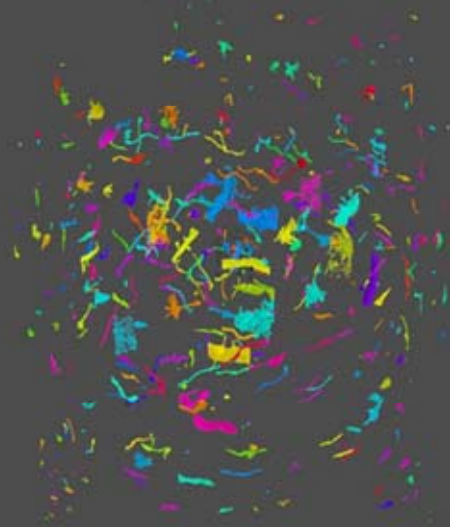
Ilastik v0.5 - Fred Hamprecht, University of Heidelberg

Synapse recognition - Anna Kreshuk

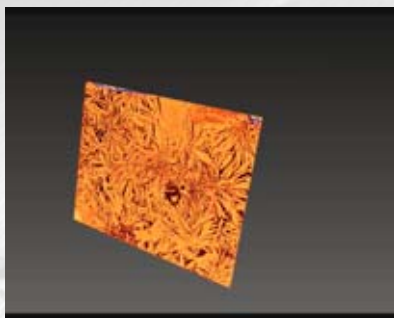


FIB Nanotomography in life science

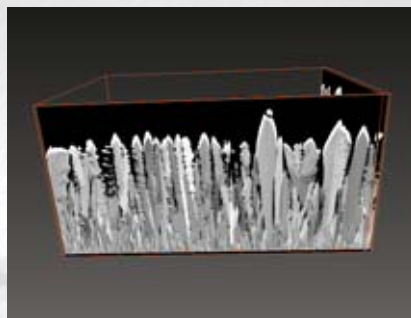
- o Specimen preparation (fixation, staining, dehydration, resin infiltration same as for BIO-TEM)
- o Image contrast and resolution TEM quality
- o Stable and reliable automated acquisition (less artifacts than ultra-microtomy)
- o To solve: segmentation and data analysis



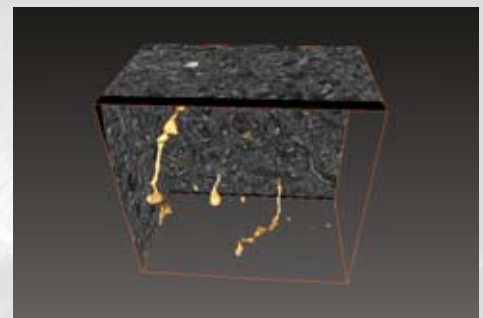
*life science and materials science
are not as far apart as one might think...*



Cement, (10nm)³ voxel



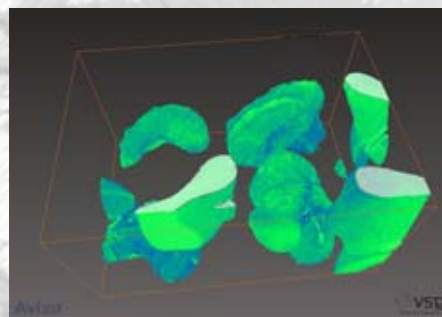
Solar cell: ZnO, (10nm)³ voxel



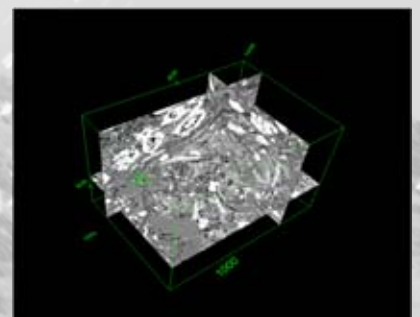
Rat brain, (5nm)³ voxel



SOFC, (10nm)³ voxel



Malaria parasite, (8nm)³ voxel



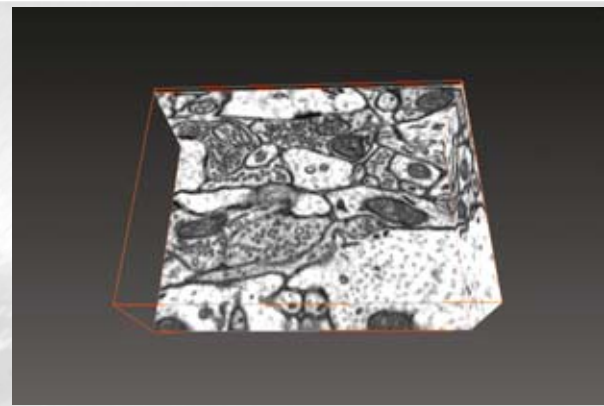
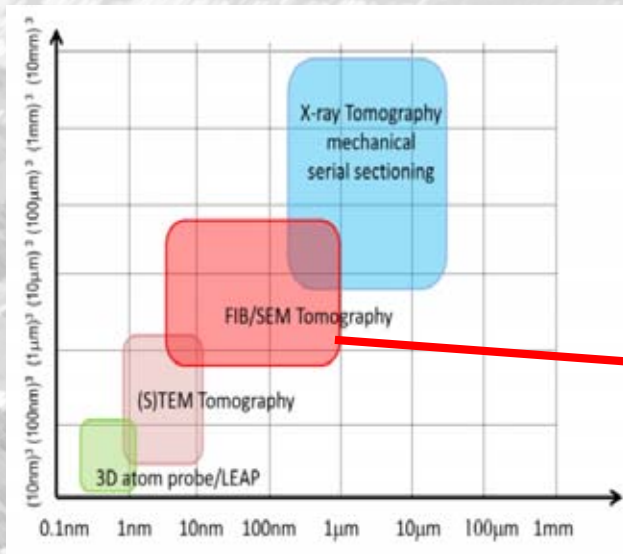
clay, (10nm)³ voxel

FIB/SEM Nanotomography, volume reconstruction
Typical voxel sizes




FIB-NT compared with other 3D-techniques

- Voxel size ~5-10nm
- Dwell time ~10 μ sec.
- 1 slice, image / min.
- HT: 1-2kV
- Escape depth of signal (BSE) \leq 5nm



3x3x3 nm voxel brain tissue

New possibilities in 3D-microscopy:
Combination with quantitative analytical SEM techniques:
EBSD, EDX



Swiss Society for Optics and Microscopy
Société Suisse pour l'Optique et la Microscopie
Schweizerische Gesellschaft für Optik und Mikroskopie

Interdisciplinary Symposium on 3D microscopy 2012

Congress Centre, Les Diablerets
5-8 March 2012

Topics:
 3D CLSM and Light Microscopy, 3D FIB/SEM or Serial Sectioning
 time resolved microscopy, 3D Image Analysis and simulation
 3D TEM Tomography and Serial Sectioning, 3D X-ray Microscopy and Tomography, Ultra-Resolution Tomography

Scientific committee and chairpersons:
 O. Bunk, M. Cantoni, F. Carbone, M. Dürrenberger, C. Genoud, L. Holzer, G. Knott, O. Medalia, A. Seitz, H. Stahlberg, P. Schwarb, R. Wepf

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